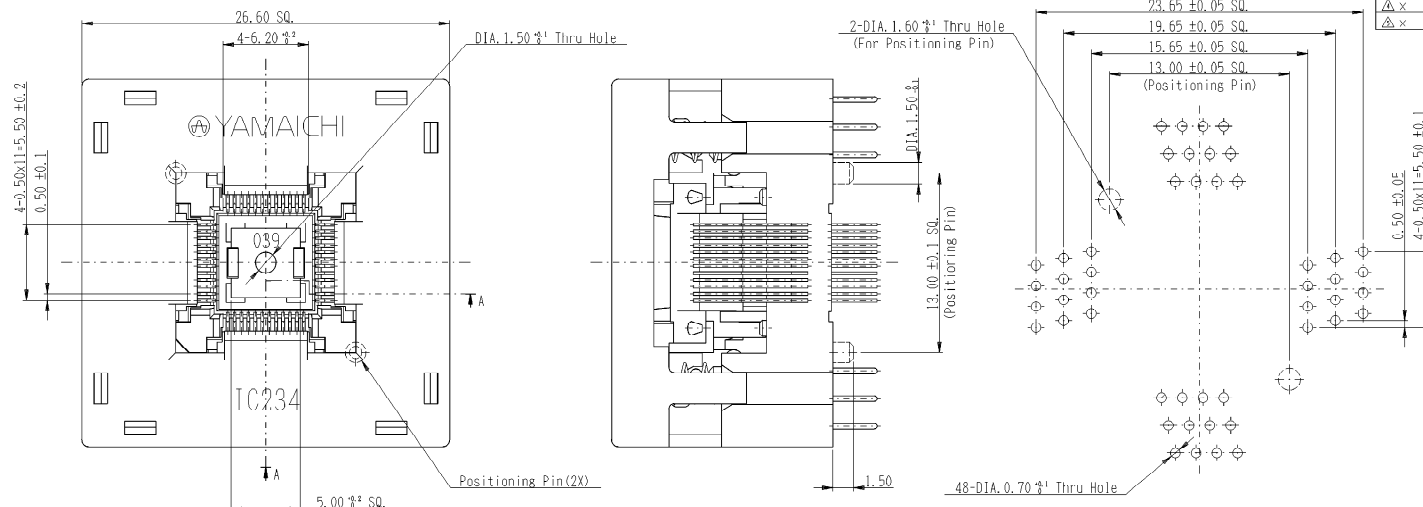


YEU-A0221

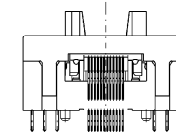
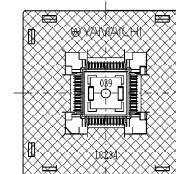
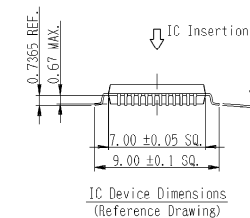
Sheet No.

No. x QTY.	REVISION DESCRIPTION	APP.	CHK.	DSGN.	Mo - D - Yr	Decision Change #
Δ x 1	Design change.	N. K.		I. I.	3-19-'98	UC 98-0757
Δ x						
Δ x						
Δ x						
Δ x						

This is the English version drawing, please note all Japanese text has been removed. Please consult factory for latest revision.



CONTACT & MOUNTING SCREW HOLE PATTERN
(Pattern shown looking down through top of socket)

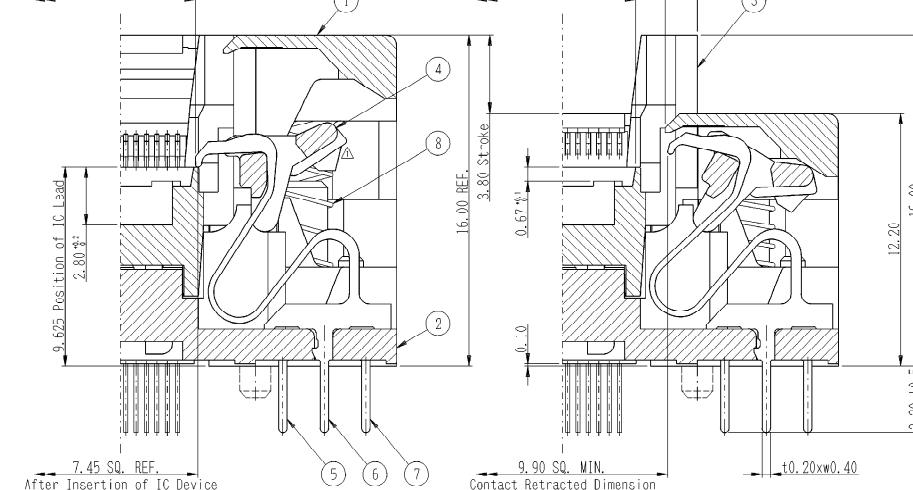


Full Stroke Condition Drawing(S=FREE)
This Device Can Be Pressed On The Hatched (XXXX) Areas Shown In The Drawing Above

Performance

1. Insulation Resistance
1,000Mohm min. at DC100V
2. Dielectric Withstanding Voltage
For 1 minute at AC100V
3. Contact Resistance
30mohm max. at 10mA and 20mV max. Initial Number
4. Operation Temperature
40deg.C +150deg.C
5. Contact Force
20g - 80g Per Pin
6. Operation Force
1.2Kg/Max.
7. Life Span
10,000 Times (Mechanical)

Free Contact Condition Dimension
7.10 SQ.



SEC. A-A(S=FREE)

SEC. A-A(S=FREE)
Contact Retracted

8	Coil Spring K1012	4	SUS DIA. 0.20	KS SANGYO No.1012	Commercial
7	Contact 2088 -C	16	BeCu t0.20	Ni-Au PL (CLASS BF)	AB-05839
6	Contact 2088 -B	16			
5	Contact 2088 -A	16			
4	IC234-0484-034 #LV	1	PES (GF)	BLACK	AB-06993
3	IC234-0484-039 #LB	1	PCI (GF)	BLACK	AB-08728
2	IC234-0484-034* #IN-B	1	PES (GF)	BLACK	AB-06991
1	IC234-0484-034 #IN-A	1	PES (GF)	BLACK	AB-06990
ITEM	DESCRIPTION	QTY.	MATERIAL	CONTENT	PART IDENT

Ordering Code

Type Name	Positioning Pin
IC234-0484-039N	Without
IC234-0484-039P	With

DU-2207						YAMAICHI ELECTRONICS USA., INC.	
TOLERANCES: ±0.3 Unless otherwise specified						(CLASS) QFP-P0.5-48P	
SCALE	2/1	APP.	CHK.	DRW.	DSGN.	(TITLE) IC234-0484-039-*	
DIMENSION	mm	3-18-'02	3-15-'02	3-15-'02	3-14-'02	(DRW. NO.)	YEU-A0222
3RD. ANGLE PROJECTION		H. Watanabe	A. Limjoco	A. Querubin	A. Querubin	Sheet No.	B